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O. Yu. Bondarenko

*Kharkiv National University of Radio Electronics, Kharkiv***OPTIMIZATION OF A PYROELECTRIC DETECTOR**

*1975-2015: 40 years ago the company "Eltec Instruments", the U.S.A., manufactured the world's first pyroelectric detector based on a single crystal such as lithium tantalate.*

*A new thermal capacity equation for obtaining the thickness of a crystal in the voltage mode is given. A new boundary condition for the equation is given as well. Geometry of the crystal in both voltage and current mode is compared.*

**Keywords:** *pyroelectric detector, optimization, time constants, heat flux.*

**Introduction**

Pyroelectrics are the subclass of thermal detectors. These can detect pulses of electromagnetic radiation in the range between ultraviolet and terahertz. The principle of operation is to generate electrical charges in response to the heat flux pulsed or permanent being chopped.

Pyroelectric detectors are used in many fields. The widest applications are flame and motion detectors. These detectors are not designed to be applied to instrumentation. However, gas analyzers, optical pyrometers, optical radiometers, electrically calibrated radiometers, or the like, are related to the instruments. Each application requires that a detector to be used, be optimized.

At least, three major criteria for thermal detectors of optimization, have been postulated [1]:

- maximum thermal isolation;
- minimum thickness of the sensor element;
- maximum area of the sensor element.

The three criteria should be considered in details. The first criterion meets the requirement that the sensitive element should be used in vacuum, with thermal losses occurring due to radiation. In this case, a thermal contact between the sensitive element and a mounting should be minimal. In practice, pyroelectric detectors as vacuum sensors are not widely produced. A problem is that the detector may collect air, moisture, dust, or other contaminants that may result in bad. For example, if the sensitive element of an open detector is observed with a microscope, one can see some parts of dust attracted by the former. These parts of dust are, at least, one more source of noise. Moisture decreases the electrical resistance of the high-ohm circuit. Air and other contaminants absorb the infrared radiation that results in false measurement [2]. In order to avoid said problems, pyroelectric detectors are filled with gas preferably optically transparent in infrared. Such a gas is found to be nitrogen [1]. This gas relates to a group of inertia gases.

Other gases from the group can be used as well [3]. As a result, it is hardly possible to meet the first criterion.

The second criterion is limited with mechanical performance. Also, it is not possible to provide the thickness of a crystal close to some layers of molecules, probably, theoretically, due to the pyroelectric effect itself may have a strange behavior. Besides, the thinner the crystal, the higher the electrical capacitance which is not always desirable. As a result, to meet the second criterion is pretty hard.

The third criterion is limited with manufacturing feasibility. It is hard enough to manufacture a single crystal of a large area. Another problem is to make the domains be uniform. This problem seems to be major and is near-impossible to control. As a result, the third criterion is not assumed to be met.

The three criteria are postulated to provide the highest output. The latter is observed at a special moment of time, hereinafter called  $t_{\max}$ , that depends on time constants. The time constants determine the transient process of a detector. However, it has been noted that the detector absorbs the energy of electromagnetic radiation pulsed, or being chopped. It is clear that when the pulse width, so-called  $t_{\text{pulse}}$ , equals  $t_{\max}$ , the output is the highest. Otherwise, it is not.

*It is an object of the paper to provide a pyroelectric detector with a predetermined  $t_{\max}$ , with the output being maximum.*

**Thermal model of a detector**

A pyroelectric detector shown on Fig.1, includes a sensitive element 1 preferably a thin wafer made of a single crystal such as lithium tantalate. The sensitive element 1 through thermal contact 2 is installed on, at least, one (or more) mounting 3. The mounting 3 is in contact with a flat supporting surface 4. Above and below the sensitive element 1 is gas.

The principal symbols used in this paper, are given in Table 1.

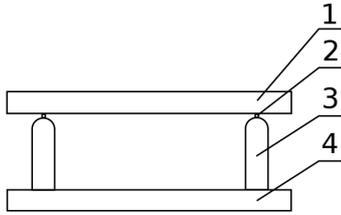


Fig. 1. A pyroelectric detector

Table 1

The principal symbols

Number	Parameter	Unit of measurement	Description
1	$t_{max}$	s	Time at which the peak output is provided
2	$t_{pulse}$	s	Time of pulse
3	$\alpha$	unitless	Absorbance of a detector
4	$\tau_W$	unitless	Transmission of a window
5	$\Phi$	W	Heat flux
6	$R_{bias}$	Ohm	Bias resistor (voltage mode)
7	$R_{fb}$	Ohm	Feedback resistor (current mode)
8	$C_{fb}$	F	Capacitance of feedback resistor (current mode)
9	$C_{E\_pyro}$	F	Capacitance of pyroelectric element
10	$C_{T\_pyro}$	J/m <sup>3</sup> K	Volume heat capacity of a detector
11	$p_{pyro}$	C/m <sup>2</sup> K	Pyroelectric coefficient
12	$d_{pyro}$	m	Thickness of a sensitive element
13	$\tau_T$	s	Thermal time constant
14	$\tau_E$	s	Electrical time constant
15	$\tau_{E\_VM}$	s	Electrical time constant (voltage mode)
16	$\tau_{E\_CM}$	s	Electrical time constant (current mode)
17	$A_{mount}^{unit}$	m <sup>2</sup>	Contact area between the sensitive element and a mounting
18	$A_{mount}$	m <sup>2</sup>	Full area between the sensitive element and a mounting
19	$C_{T\_mount}$	J/m <sup>3</sup> K	Volume heat capacity of a mounting
20	$d_{mount}$	m	Height of a mounting
21	$\lambda_{mount}$	W/m K	Thermal conductivity of a mounting
22	$\epsilon_0$	F/m	Dielectric constant
23	$\epsilon_{pyro}$	unitless	Dielectric constant of a detector
24	$C_{T\_gas}$	J/m <sup>3</sup> K	Volume heat capacity of gas
25	$d_{gas\_top}$	m	Gas layer above a detector
26	$d_{gas\_btm}$	m	Gas layer below a detector
27	$\sigma$	W/m <sup>2</sup> K <sup>4</sup>	Stefan-Boltzman constant
28	$T_0$	K	Ambient temperature
29	$\lambda_{gas}$	W/m K	Thermal conductivity of gas
30	$C_{JFET}$	F	JFET input electrical capacitance
31	$t$	s	Time
32	$u_{pyro}(t)$	V	Output voltage of a detector

The thermal time constant  $\tau_T$  is known to be an important parameter that defines the thermal transient process of a detector. It can be described as  $\tau_T = C_T / G_T$  where  $C_T$  being thermal capacitance of the detector;  $G_T$  being thermal loss of that. Thermal capacitance  $C_T$  is the sum of thermal capacitances of the detector element  $C_{T\_pyro\_det}$ , gas layers above  $C_{T\_gas\_top}$  and below  $C_{T\_gas\_btm}$  the detector, and thermal capacitance of the mounting  $C_{T\_mount}$ . Thermal loss  $G_T$  is the sum of thermal losses of radiation  $G_{Rad}$ , gas layers above  $G_{T\_gas\_top}$  and below  $G_{T\_gas\_btm}$  the detector, and thermal conductivity of the mounting  $G_{T\_mount}$ . Thermal capacitance  $C_T$

$$C_T = C_{T\_gas} A_{pyro} d_{gas\_top} + C_{T\_gas} A_{pyro} d_{gas\_btm} + C_{T\_pyro} A_{pyro} d_{pyro} + C_{T\_mount} A_{mount} d_{mount}, \quad (1)$$

and thermal losses  $G_T$

$$G_T = \lambda_{gas} \frac{A_{pyro}}{d_{gas\_top}} + \lambda_{gas} \frac{A_{pyro}}{d_{gas\_btm}} + \lambda_{mount} \frac{A_{mount}}{d_{mount}} + 4\sigma A_{pyro} T_0^3 \quad (2)$$

are equal to correspondingly [1,4].

### Electrical model of a detector

*Voltage mode.* A pyroelectric detector connected to a JFET, is called a detector working in voltage mode. In the voltage mode, the electrical time constant  $\tau_{E\_VM}$  is determined as a product of electrical resistance  $R_{E\_VM}$  and electrical capacitance  $C_{E\_VM}$ . The former is the inversed sum of electrical resistance of the crystal  $R_{pyro}$ , bias resistor  $R_{bias}$ , and the input resistance of a JFET  $R_{JFET}$ . The latter is that of electrical capacitance of the crystal  $C_{E\_pyro}$ , bias resistor  $C_{R\_bias}$ , and the input capacitance of the JFET  $C_{E\_JFET}$ . In principle, the values  $R_{pyro}$  and  $R_{JFET}$  are too high and can be neglected. The value  $C_{R\_bias}$  is low enough and can be done as well. Therefore, the electrical time constant in the voltage mode equals

$$\tau_{E\_VM} = R_{bias} (C_{E\_pyro} + C_{JFET}), \quad (3)$$

where

$$C_{E\_pyro} = \epsilon_0 \epsilon_{pyro} \frac{A_{pyro}}{d_{pyro}}. \quad (4)$$

*Current mode.* If a detector is connected to an operational amplifier (current mode), then the electrical time constant is a product of electrical resistance of a

feedback resistor  $R_{fb}$  and its capacitance  $C_{fb}$ . In the current mode, the electrical time constant is [1]:

$$\tau_{E\_CM} = R_{fb}C_{fb}. \quad (5)$$

### Solution

*Voltage mode.* The output is described as [5]:

$$u_{pyro}(t) = \alpha\tau_W \widehat{\Phi} R_{bias} \times \frac{P_{pyro}}{C_{T\_pyro}} \frac{1}{d_{pyro}} \left( e^{-t/\tau_E} - e^{-t/\tau_T} \right). \quad (6)$$

The output reaches its maximum at the point

$$t_{max} = \ln \frac{\tau_T}{\tau_E} \left( \frac{1}{\tau_E} - \frac{1}{\tau_T} \right)^{-1} \quad (7)$$

of time [6].

From here, new criteria of optimization can be postulated:

– the time  $t_{max}$  should be equal to the pulse width  $t_{pulse}$ ;

– the output should be maximum.

It is seen from the equation (7) that  $t_{max}$  depends on two variables and, therefore, has a set of solutions. Let  $t_{max}$  be a predetermined value. The time constants  $\tau_T$  and  $\tau_E$  are set in the range  $\{a_T; b_T\}$  and  $\{a_E; b_E\}$  correspondingly. Step may be chosen individually. Let  $t_{max} = x$  [s]. Then, one should select the couples of  $\tau_T$  and  $\tau_E$  which give the smallest difference between  $x$  and the result. If necessary, the step can be decreased.

The thermal capacity equation found by the author, give the solution for the thickness of a crystal

$$Az^2 + Bz + C = 0, \quad (8)$$

where

$$A = P_2 N_1;$$

$$B = P_1 (M_1 N_1 - M_2 N_2);$$

$$C = A_{mount} \left( C_{T\_mount} d_{mount} - \tau_T \frac{\lambda_{mount}}{d_{mount}} \right);$$

$$P_1 = \frac{1}{\varepsilon_0 \varepsilon_{pyro}};$$

$$P_2 = P_1 C_{T\_pyro};$$

$$M_1 = C_{T\_gas} (d_{gas\_top} + d_{gas\_btm});$$

$$M_2 = \tau_T \left( 4\sigma T_0^3 + \lambda_{gas} \left( \frac{1}{d_{gas\_top}} + \frac{1}{d_{gas\_btm}} \right) \right);$$

$$N_1 = \frac{\tau_E}{R_{bias}} - C_{JFET};$$

$$N_2 = \frac{\tau_E}{R_{bias}} + C_{JFET}.$$

The equation (8) has two roots. One root is negative and should be given up. Another root is positive and can be taken into account. Therefore

$$z = d_{pyro} = \frac{-B + \sqrt{B^2 - 4AC}}{2A}, \quad (9)$$

under a boundary condition

$$d_{mount} < \sqrt{\tau_T \frac{\lambda_{mount}}{C_{T\_mount}}}. \quad (10)$$

If the boundary condition (10) is not satisfied, then the root (9) of the equation (8) has no real value.

*Current mode.* In the current mode, the detector is connected to an operational amplifier. The electrical time constant is the product of resistance of a feedback resistor and its capacitance. Here, the equation (7) has the only solution relatively to the thermal time constant. It means that in contrast to the voltage mode, the current mode provides the only couple of the time constants that satisfy the optimization. Therefore, geometry for a detector have to be chosen according to thermal properties of the detector only. It is necessary to determine the thickness of the crystal that is

$$d_{pyro} = \frac{1}{A_{pyro}} \times \left( \frac{\tau_T \lambda_{mount} A_{mount}}{C_{T\_pyro} d_{mount}} - \frac{C_{T\_mount} A_{mount} d_{mount}}{C_{T\_pyro}} \right) + \frac{\tau_T}{C_{T\_pyro}} \left( \lambda_{gas} \left( \frac{1}{d_{gas\_top}} + \frac{1}{d_{gas\_btm}} \right) + 4\sigma T_0^3 \right) - \frac{C_{T\_gas}}{C_{T\_pyro}} (d_{gas\_top} - d_{gas\_btm}) \quad (11)$$

### Discussion

*Current mode.* The equation (11) shows that the best solution can be obtained if the crystal has infinite area and zero thickness. This does correspond to the second criterion of optimization given in [1], but differs from the one used in the voltage mode. The crystal area can be chosen depending on the market requirements and is limited by technological options. The ratio between the thickness and the area should satisfy mechanical performance of the crystal. The parameters other than the thickness and the area, are discrete and, therefore, can't be changed widely. Therefore, it is not necessary to plot graphs or draw tables for them.

*Voltage mode.* It is obvious that in order to satisfy the equation (7), the root (9) is influenced by other parameters. These influences are given in the Table 2. The top line shows the parameters to be, here, for instance, increased. The bottom line shows if the crystal should be thicker or thinner.

Table 2

Influences by other parameters

$\uparrow$	$R_{bias}$	$d_{gas\_btm}$	$d_{gas\_top}$	$C_{mount}$	$\lambda_{mount}$	$C_{gas}$	$\lambda_{gas}$	$C_{JFET}$	$A_{mount}$
$z = d_{pyro}$	$\uparrow$	$\downarrow$	$\downarrow$	$\downarrow$	$\uparrow$	$\downarrow$	$\uparrow$	$\uparrow$	$\uparrow$

The parameters given in the Table 2, are discrete. It means that it is impossible to set a range of each of them separately. It is not necessary to plot graphs as well.

The bias resistor is chosen from the list. The gas layers above  $d_{gas\_top}$  and below  $d_{gas\_btm}$  the crystal are characterized by the field of view that is dictated by the market. The height of a mounting  $d_{mount}$  in this paper equals the gas layer  $d_{gas\_btm}$  below the crystal. The parameters, thermal capacitance of a mounting  $C_{T\_mount}$ , thermal capacitance of gas  $C_{T\_gas}$ , thermal conductivity of the mounting  $\lambda_{mount}$ , thermal conductivity of gas  $\lambda_{gas}$ , are set depending on material used for the mounting, and gas correspondingly. The input electrical capacitance  $C_{JFET}$  is considered to be constant and is taken from the specification.

The last parameter is the area of thermal contact  $A_{mount}$  between the crystal and the mounting. This parameter is not discrete. It determines how much energy is lost due to thermal conductance through the mounting.

However, probably, it is not possible to provide  $A_{mount}$  too low due to technological restrictions.

Let the unit area for the thermal contact  $A_{mount}^{unit}$  be  $y$  [ $mm^2$ ]. Let the number of mountings be  $n$ . Then, the value  $A_{mount}$  equals the sum of  $n$  mountings  $A_{mount}^{unit}$ , i.e.  $A_{mount} = ny$  [ $mm^2$ ].

The couples  $\tau_T$  and  $\tau_E$ , which have already been found, in combination with the other parameters are put in the equation (6). The maximum output will be ob-

tained at the only couple of  $\tau_T$  and  $\tau_E$  that satisfies the new criteria of optimization.

### Conclusion

It has been shown that for a pyroelectric detector with the predetermined  $t_{max}$  in the voltage mode, the highest output may be achieved when the crystal is as small as possible. In contrast, in the current mode, the large area is preferable. The thickness of the crystal is known to be as small as possible.

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**Рецензент:** д-р техн. наук, ст. наук. співр. С.Г. Семенов, Національний технічний університет «Харківський політехнічний інститут», Харків.

### ОПТИМІЗАЦІЯ ПІРОЕЛЕКТРИЧНОГО ДЕТЕКТОРА

О.Ю. Бондаренко

Наводиться нове рівняння теплоємностей для визначення величини товщини кристала в режимі роботи по напрузі. Також для даного рівняння наводиться гранична умова. Порівнюються геометричні фактори кристалів в режимі роботи по напрузі і струму. Показано, що для піроелектричного детектора із заданим часом досягнення максимального сигналу, геометричні розміри повинні бути мінімально можливими, а в режимі роботи по струму переважно використання кристалів великої площі.

**Ключові слова:** піроелектричний детектор, оптимізація, сталі часу, тепловий потік.

### ОПТИМИЗАЦИЯ ПИРОЭЛЕКТРИЧЕСКОГО ДЕТЕКТОРА

А.Ю. Бондаренко

Приводится новое уравнение теплоемкостей для определения величины толщины кристалла в режиме работы по напряжению. Также для данного уравнения приводится граничное условие. Сравниваются геометрические факторы кристаллов в режиме работы по напряжению и току. Показано, что для пироэлектрического детектора с заданным временем достижения максимального сигнала, геометрические размеры должны быть минимально возможными, а в режиме работы по току предпочтительно использование кристаллов большой площади.

**Ключевые слова:** пироэлектрический детектор, оптимизация, постоянные времени, тепловой поток.